Software design specification



Infineon Arduino Library Documentation

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1 Hierarchical Index

1.1 Class Hierarch

This inheritance list is sorted roughly, but not completel	ly, alphabetically:
SignalInput	
XMCl2SClass	



2 Class Index

2.1 Class L	ist	
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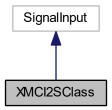
Here are the classes, structs, unions and interfaces with brief descriptions:
XMCI2SClass



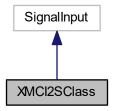
3 Class Documentation

3.1 XMCI2SClass Class Reference

Inheritance diagram for XMCI2SClass:



Collaboration diagram for XMCI2SClass:



Public Member Functions

- XMCI2SClass (bool isMono=true, uint8_t bitsPerSample=16)
 Constructor of the I2S class.
- void begin ()

Starts I2S communication with default configuration.

- void begin (uint32_t samplingRate, uint8_t frameLength=32, uint8_t dataDelay=1, uint8_t dataBits=16)

 Starts I2S communication.
- void end ()

Ends I2S communication with default configuration.

• int peek ()



Returns the latest received sample.

void read (int16_t *readBuffer, uint16_t readSize)

Copies samples into an int array.

void enableMasterClock ()

Enables master clock output signal with a fixed phase relation to the shift clock to support oversampling for audio components.

uint16_t available ()

Returns the number of samples in buffer available for read.

void onSampleReceived ()

Read in one sample on rising/falling edge of WA signal.

void downScaleByTwo ()

Reduces the sampling frequency by half; this function can be used to sample at below the lowest frequency of the microphone.

void configureInterrupt (interrupt_cb_t callback)

Configures the interrupt generated when the buffer for audio samples is full.

Static Public Member Functions

• static void dmaCallback ()

Wrapper function for custom callback. Toggles the _inDmalnProgress flag.

3.1.1 Constructor & Destructor Documentation

3.1.1.1 XMCI2SClass()

```
XMCI2SClass::XMCI2SClass (
          bool isMono = true,
          uint8_t bitsPerSample = 16 )
```

Constructor of the I2S class.

Parameters

is Mono if mono channel is enabled and is set to true by default. If you are using the Adafruit microphone breakout, this corresponds to an unconnected SEL.

3.1.2 Member Function Documentation



3.1.2.1 begin()

Starts I2S communication.

Parameters

samplingRate	samples per seconds
dataBits	length of one data frame. Ranges from 1 to 16 (size of the FIFO buffer)
frameLength	number of bits between 2 changing edges
dataDelay	the number of clock cycles after which a transmission of one samples is started

3.1.2.2 configureInterrupt()

Configures the interrupt generated when the buffer for audio samples is full.

Parameters

callback	the callback where data processing happens.

3.1.2.3 read()

Copies samples into an int array.

Parameters

readBuffer	the user-defined buffer of integers.
readSize	number of samples that should be copied into the buffer. Must be smaller than the buffer's length



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